05-07-2001



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To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.			
1. Name of Conveying Party(ies): Yoichi UEHARA and Katsumi YAMAMOTO Additional names of conveying parties attached	2. Name and Address of Receiving Party(ies): Name: Hitachi Ltd. Internal Address:		
3. Nature of Conveyance:	Street Address: 6, Kanda Surugadai 4-chome City, State, Zip: Chiyoda-ku, Tokyo, Japan		
4. (a) Patent Application Number(s):	4. (b) Patent Numbers:		
If this document is being filed together with a new application, to execution date of the application is: March 14, 2001 Additional Numbers Attached.	the		
5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:	6. Total Number of Applications and Patents Involved: 1		
Name: Stanley P. Fisher	7. Total Fee: \$40.00 (37 C.F.R. § 3.41)		
Address: Reed Smith Hazel Thomas LLP 3110 Fairview Park Dr. Suite 1400 Falls Church, Va. 22042			
DO NOT USE THIS SPACE			
O Statement and Signature:			
To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document. April 24, 2001			
Stanley P. Fisher, Registration No. 24,344 Total number of pages comprising cover sheet: 1			

04 FC:581

PATENT REEL: 011754 FRAME: 0463

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR INTEGRATED CIRCUIT

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire owner-ship of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be grantey and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been mad;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

RECORDED: 04/24/2001

	INVENTOR(S) (発明者フルネームサイン)	(署名日)
1)	Yorchi Uchara (Yoici UEHARA)	14/March/2001
	Katsumi Yamamoto (Katsumi YAMAMOTO)	14/ March / 2001
3) _		
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10)		

PATENT REEL: 011754 FRAME: 0464